



## Selection Guide

| Part No.      | Dice                      | Lens Type    | Iv (mcd) [2]<br>@ 20mA |      | Viewing<br>Angle [1] |
|---------------|---------------------------|--------------|------------------------|------|----------------------|
|               |                           |              | Min.                   | Typ. | 2θ1/2                |
| WP4060VH/2SRD | Super Bright Red (GaAlAs) | Red Diffused | 100                    | 250  | 70°                  |

Notes:

1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

| Symbol | Parameter                | Device           | Typ. | Max. | Units | Test Conditions |
|--------|--------------------------|------------------|------|------|-------|-----------------|
| λpeak  | Peak Wavelength          | Super Bright Red | 660  |      | nm    | IF=20mA         |
| λD [1] | Dominant Wavelength      | Super Bright Red | 640  |      | nm    | IF=20mA         |
| Δλ1/2  | Spectral Line Half-width | Super Bright Red | 20   |      | nm    | IF=20mA         |
| C      | Capacitance              | Super Bright Red | 45   |      | pF    | VF=0V;f=1MHz    |
| VF [2] | Forward Voltage          | Super Bright Red | 1.85 | 2.5  | V     | IF=20mA         |
| IR     | Reverse Current          | Super Bright Red |      | 10   | uA    | VR = 5V         |

Notes:

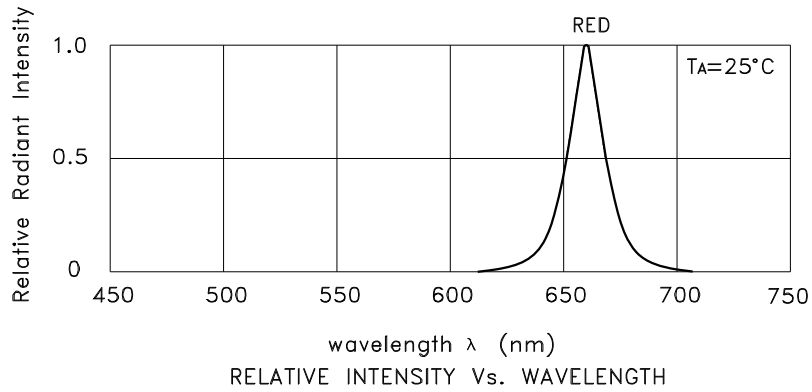
- 1.Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

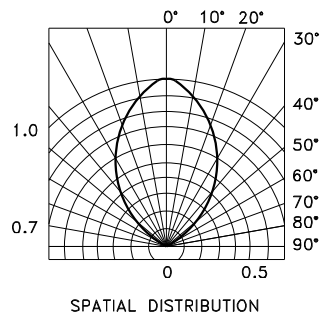
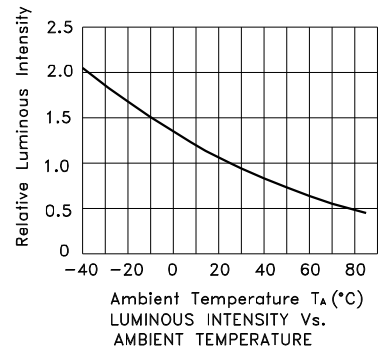
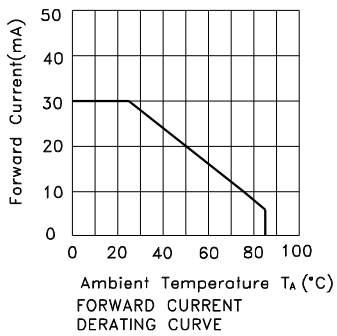
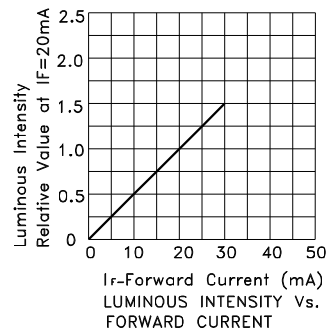
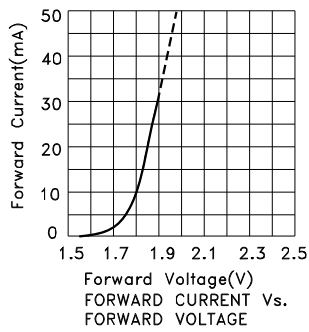
| Parameter                     | Super Bright Red    | Units |
|-------------------------------|---------------------|-------|
| Power dissipation             | 75                  | mW    |
| DC Forward Current            | 30                  | mA    |
| Peak Forward Current [1]      | 155                 | mA    |
| Reverse Voltage               | 5                   | V     |
| Operating/Storage Temperature | -40°C To +85°C      |       |
| Lead Solder Temperature [2]   | 260°C For 3 Seconds |       |
| Lead Solder Temperature [3]   | 260°C For 5 Seconds |       |

Notes:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.
2. 2mm below package base.
3. 5mm below package base.

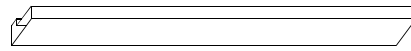
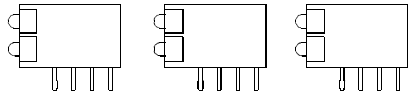


## Super Bright Red WP4060VH/2SRD

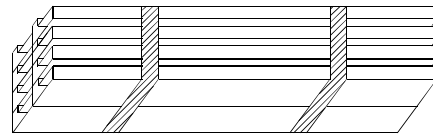


**PACKING & LABEL SPECIFICATIONS**

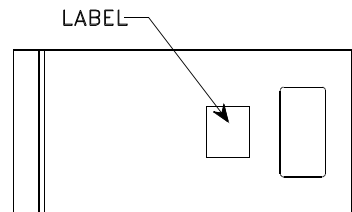
**WP4060VH/2SRD**



190 PCS / IC TUBE



1.52K / 8PCS IC TUBE




8PCS IC TUBE / BAG



OUTSIDE LABEL

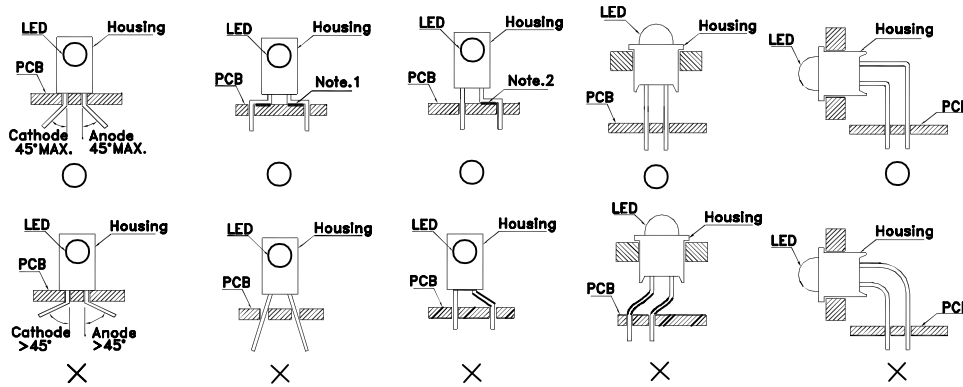


12.16K / BOX

|  |  |
|--|--|
| <h1>Kingbright</h1>  |  |
| P/NO: WP4060VHxxx  |  |
| QTY: 1520 pcs  | Q.C. <span style="border: 1px solid black; border-radius: 50%; padding: 2px;">Q C<br/>XX XX XXXX<br/>PASSED</span> |
| S/N: XXXX  |  |
| CODE: XXX  |  |
| LOT NO:  |  |
| <br>xxxxxxxxxxxxxxxxxxxxxxxx |  |
| RoHS Compliant   |  |

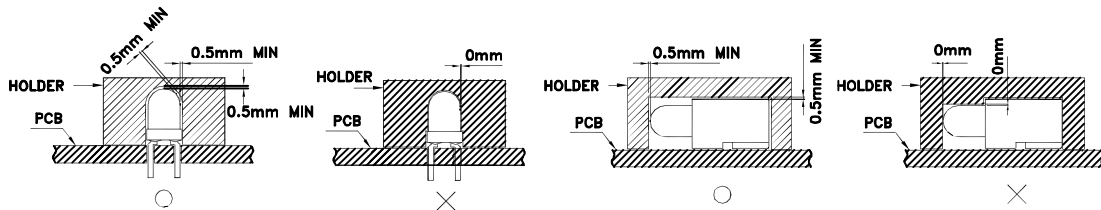
## PRECAUTIONS

- The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures.

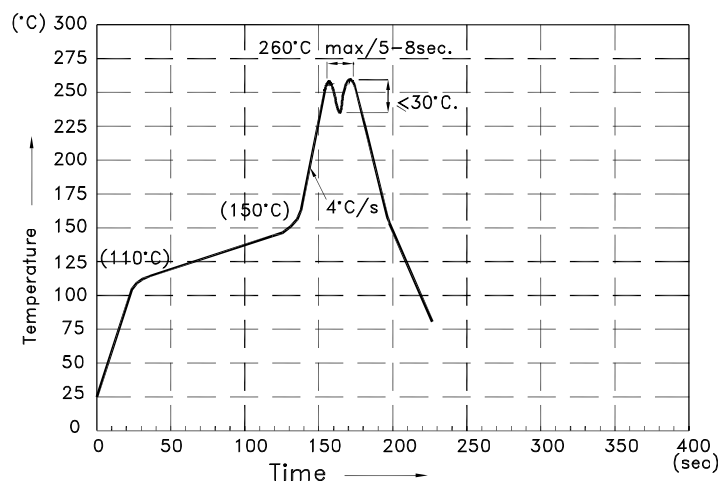


”○” Correct mounting method ”×” Incorrect mounting method

- During soldering, component covers and holders should leave clearance to avoid placing damaging stress on the LED during soldering.



- The tip of the soldering iron should never touch the lens epoxy.
- Through-hole LEDs are incompatible with reflow soldering.
- If the LED will undergo multiple soldering passes or face other processes where the part may be subjected to intense heat, please check with Kingbright for compatibility.
- Recommended Wave Soldering Profile for Kingbright Thru-Hole Products



### NOTES:

- Recommend the wave temperature 245°C~260°C. The maximum soldering temperature should be less than 260°C.
- Do not apply stress on epoxy resins when temperature is over 85°C.
- The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- During wave soldering, the PCB top-surface temperature should be kept below 105°C.
- No more than once.